

# Huawei Joins Group Of Global OEMs Accelerating Adoption Of China's TD-SCDMA Standard With New Ultra-Thin 'Super' Smartphone Powered By Marvell's Single-Chip Solution

**Marvell's high performance single-chip TD-SCDMA solution continues to win over the industry; Huawei's new T8300 ultra-thin smartphone currently available through China Mobile**

BEIJING, Aug. 10, 2011 /PRNewswire/ -- Marvell (Nasdaq: MRVL), a worldwide leader in integrated silicon solutions, today announced that Huawei's new T8300 ultra-thin smartphone, powered by Marvell's industry's first commercially available TD-SCDMA single chip solution, has passed China Mobile's rigorous testing requirements and has shipped to its stores throughout China. The ultra-thin Huawei T8300 measures only 11.2 millimeters thick with Marvell® PXA918 processor and is one of the six new smartphones selected by China Mobile in its first round of procurement this year.

(Logo: [https://investor.marvell.com/image/Marvell\\_logo.jpg](https://investor.marvell.com/image/Marvell_logo.jpg))

"Mass adoption of China's TD-SCDMA standard is accelerating rapidly as more manufacturers come to leverage the technical and economic advantages of Marvell's single-chip solution. Huawei's new ultra-thin super smartphone is just the latest example of why TD-SCDMA will soon become the world's standard for full-featured, highly affordable smart devices," said Weili Dai, Marvell's Co-Founder. "For Marvell, the fast acceptance of the TD-SCDMA standard is very gratifying and reflects three years of hard work by our engineers in partnership with China Mobile. We're proud of our leadership role in this important new technology and we're very pleased that Huawei was able to leverage the low-power and tiny efficient design and versatility of Marvell's TD-SCDMA solution to create a sleek and ultra-thin smartphone aimed at millions of China Mobile customers. I look forward to further collaborations with Huawei to deliver exciting new TD smart devices."

"Marvell's TD-SCDMA single chip solution was the only semiconductor that offered the high-performance processing power and low power consumption we required to deliver a powerful, stylish, multimedia TD smartphone at the right price," said Mr. Wang Yanmin, President of Mobile Phone Product Line, Huawei Device. "With its long-term commitment to TD and its leadership in the market, we were confident that Marvell could seamlessly deliver the right technology efficiently and be a true partner in bringing our new T8300 smartphone to market."

Huawei's T8300 is also equipped with Marvell's latest 802.11n Wi-Fi solution and runs OMS 2.5, the newest Ophone operating system. It features a 3.2 inch capacitive touchscreen, 720p video decoding and gravity, light and proximity sensors.

## About Marvell

Marvell is a world leader in the development of storage, communications, and consumer silicon solutions. Marvell's diverse product portfolio includes switching, transceiver, communications controller, wireless, and storage solutions that power the entire communications infrastructure including enterprise, metro, home, and storage networking. As used in this release, the term "Marvell" refers to Marvell Technology Group Ltd. and its subsidiaries. For more information, visit [Marvell.com](http://Marvell.com).

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For Further Information Contact:

Marvell's China Media  
Relations  
Gail Liu  
Tel: 8610-82151511  
gailliu@marvell.com

Marvell Media Relations  
Daniel Yoo  
Tel: 408.222.2187  
yoo@marvell.com

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